





2.0 mm x 2.5 mm Ceramic Package SMD TCXO

1587/1787 Series

Product Features:

Low Current Consumption Ultra-Miniature Package RoHS Compliant Analog Temperature Compensation Applications:

GPS, GPS Module CDMA / WCDMA 802.11 / Wifi T1/E1, T3/E3

Output Specifications				
Frequency	13.000MHz to 52.000MHz (Contact Sales			
	Channel for Available Frequencies			
Frequency Tolerance	±2.0 ppm (at +25°C±3°C, referenced to nominal			
	frequency, 60 minutes after 2nd reflow)			
Frequency Stability				
Frequency Stability vs Temperature	±0.5 ppm Maximum (Inclusive of Operating			
Farmer Otability //s //slts as	Temperature Range)			
Frequency Stability Vs. Voltage Frequency Stability Vs. Load	±0.2 ppm Maximum (±5%) ±0.2 ppm Maximum (±1kOhm//±1pF)			
Aging (at 25°C)	±1.0 ppm Maximum First Year			
Supply Voltage (Vcc)	See Part Number Guide; Tolerance ±5%			
Input Current (Icc)	2.0mA Maximum (Nominal Frequency less than			
input current (icc)	or equal to 32MHz)			
	2.5mA Maximum (Nominal Frequency over			
	32MHz)			
Start-up Time	3mSec Maximum			
Output Level				
Clipped Sinewave	0.8Vp-p Minimum			
Harmonics	-8dBc Maximum			
Output Load	10kOhms//10pF			
SSB Phase Noise (at 25°C, Typ.)	-87dBc/Hz at 10Hz offset			
	-112dBc/Hz at 100Hz offset			
	-135dBc/Hz at 1kHz offset -145dBc/Hz at 10kHz offset			
Operating Temperature Dance				
Operating Temperature Range	See Part Number Guide			
Absolute Maximum Rating				
	-40°C to +85°C			
Storage Temperature Supply Voltage (Vcc)	-40 C to +85 C -0.6 VDC to +4.6 VDC			
Control Voltage (Vc)	-0.6 VDC to Vcc ±0.5 VDC (I787 Only)			
Control voltage (vc)	-0.0 VDO 10 VCC ±0.3 VDO (1/0/ Offily)			

Voltage Control Characteristics		
Frequency Deviation	±5ppm Minimum	
Control Voltage Center and Range	1.5Vdc ±1.0Vdc	
Slope	Positive	
Linearity	±10%	
Input Impedance	500kOhms Minimum	

2.50±.10 Marking Top View Pin 1 Indicators Located		
in this area		
1.00 Max		
- → .95 -		
'		
68 4 3		
1 1 -		
1.80		
95 -		
Recommented Pad Layout		
Din Conrections		
Pin Connections 1587 Ground		
Pin 1 1787 Control Voltage		
Pin 2 Ground		
Pin 3 Output		
Pin 4 Supply Voltage (Vcc)		
Dimension Units: mm		

Part Number Guide						
Sample Part Number: I587-5Y3-26.000 MHz						
Package	Operating Temperature Range	Frequency Stability vs. Temperature	Supply Voltage	Frequency	Suffix	
I587 (Clipped Sinewave TCXO)	5 = -30°C to +85°C	$Y = \pm 0.5$ ppm Max	3 = +3.3 VDC	XX.XXX or XX.XXXX = Nominal Frequency (5 or 6 Digits + Decimal)	MHz = Megahertz	
I787 (Clipped Sinewave VCTCXO)			7 = +3.0 VDC			
			8 = +2.8 VDC			



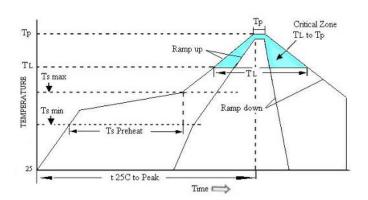




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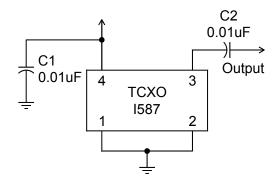
Pb Free Solder Reflow Profile:

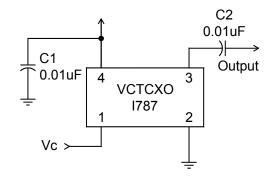


Units are backward compatible with +240°C reflow processes

Ts max to T _L (Ramp-up Rate)	3°C / second max
Preheat Temperature min (Ts min) Temperature typ (Ts typ) Temperature max (Ts max) Time (Ts)	150°C 175°C 200°C 60 to180 seconds
Ramp-up Tate (T∟ to Tp	3°C / second max
Time Maintained Above Temperature (T_L) Time (T_L)	217°C 60 to 150 seconds
Peak Temperature (Tp)	260°C max for seconds
Time within 5°C to Peak Temperature (Tp)	20 to 40 seconds
Ramp-down Rate	6°C / second max
Tune 25°C to Peak Temperature	8-minute max
Moisture Sensitivity Level (MSL)	Level 1

Circuit Configuration:





Notes:

- It is recommended that a 0.01 µF bypass capacitor be connected between Vcc (Pin 4) and Ground (Pin 2) to minimize power supply noise.
- It is recommended that an external 0.01 µF AC-coupling capacitor be connected to output (Pin 3) of the device.
- For the TCXO (I587) Pin 1 should not be left floating but must be connected to ground.

Environmental Specifications:

Thermal Shock	MIL-STD-883, Method 1011, Condition A
Moisture Resistance	MIL-STD-883, Method 1004
Mechanical Shock	MIL-STD-883, Method 2002, Condition B
Mechanical Vibration	MIL-STD-883, Method 2007, Condition A
Resistance to Soldering Heat	J-STD-020C, Table 5-2 Pb-free devices (except 2 cycles max)
Hazardous Substance	Pb-Free / RoHS / Green Compliant
Solderability	JESD22-B102-D Method 2 (Preconditioning E)
Terminal Strength	MIL-STD-883, Method 2004, Test Condition D
Gross Leak	MIL-STD-883, Method 1014, Condition C
Fine Leak	MIL-STD-883, Method 1014, Condition A2, R1=2x10-8 atm cc/s
Solvent Resistance	MIL-STD-202, Method 215

QUALITY SYSTEM

ILSI America Phone 775-851-8880 ● Fax 775-851-8882 ●email: e-mail@ilsiamerica.com ●

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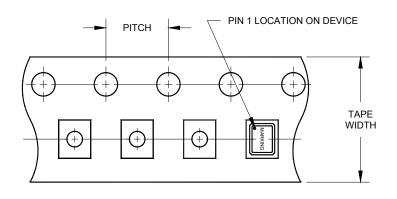




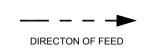


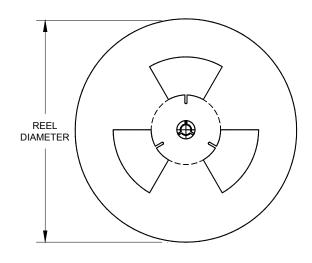


Tape and Reel Information:



PITCH:	4.00	
TAPE WIDTH:	8.00	
REEL DIAMETER:		
QTY PER REEL MAX:	1000	
Compliant to EIA-481		
All Dimensions in Millimeters		





Package Information:

MSL = 1

Termination = e4 (Au over Ni over W base metallization)

Marking:

Line 1: I-Date Code (yww) Line 2: Frequency

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